imall

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175°C 60V DUAL P-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BV _{DSS}	RDS(ON) Max	Ι _D T _A = +25°C
-60V	48mΩ @ V _{GS} = -10V	-5.2A
	$60m\Omega @ V_{GS} = -4.5V$	-4.7A

Description

This new generation MOSFET is designed to minimize the on-state resistance ($R_{DS(ON)}$), yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

Applications

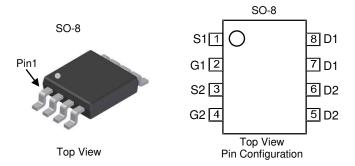
- Engine Management Systems
- Body Control Electronics
- DC-DC Converters

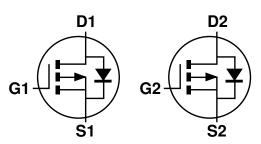
Features

- Rated to +175°C ideal for high ambient temperature environments
- 100% Unclamped Inductive Switching ensures more reliable and robust end application
- Low R_{DS(ON)} minimises power losses
- Low Qg minimises switching losses
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- An Automotive-Compliant Part is Available Under Separate Datasheet (<u>DMPH6050SSDQ</u>)

Mechanical Data

- Case: SO-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.076 grams (Approximate)





Equivalent Circuit

Ordering Information (Note 4)

Part Number	Case	Packaging
DMPH6050SSD-13	SO-8	2500 / Tape & Reel

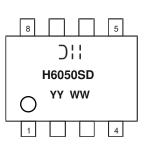
Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



) :: = Manufacturer's Marking H6050SD = Product Type Marking Code YYWW = Date Code Marking YY or \overline{YY} = Year (ex: 16 = 2016) WW = Week (01 to 53)



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage	V _{DSS}	-60	V		
Gate-Source Voltage	V _{GSS}	±20	V		
Continuous Drain Current (Note 6) V _{GS} = -10V	Steady State	T _A = +25°C T _A = +100°C	ID	-5.2 -3.7	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	I _{DM}	-35	А		
Maximum Continuous Body Diode Forward Current (Note 6)	ls	-2.0	А		
Avalanche Current (Note 7) L = 0.1mH			I _{AS}	-25	А
Avalanche Energy (Note 7) L = 0.1mH			E _{AS}	33	mJ

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Total Power Dissipation (Note 5)	$T_A = +25^{\circ}C$	PD	1.5	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady state	D	103	°C/W
memai nesistance, sunction to Ambient (Note 5)	t<10s	$R_{ ext{ heta}}JA$	64	
Total Power Dissipation (Note 6)	T _A = +25°C	PD	2.0	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady state	D	75	°C/W
Thermal Resistance, sunction to Amplent (Note 6)	t<10s	$R_{\theta JA}$	47	
Thermal Resistance, Junction to Case (Note 6)		R _{eJC}	13	
Operating and Storage Temperature Range		TJ, TSTG	-55 to +175	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

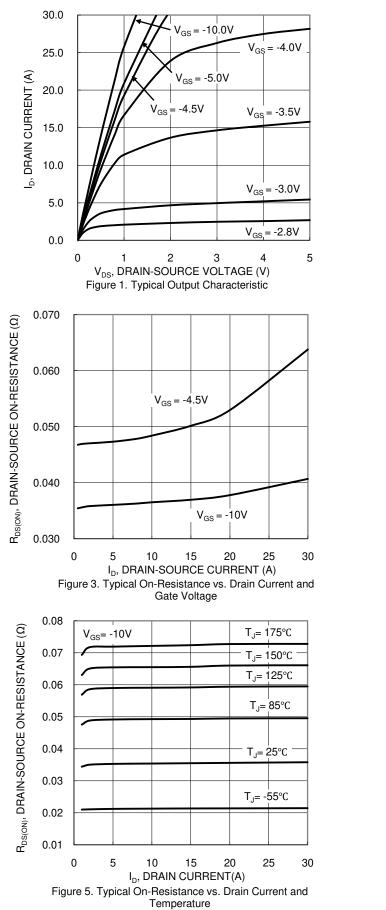
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)							
Drain-Source Breakdown Voltage	BV _{DSS}	-60	—	—	V	$V_{GS} = 0V, I_D = -250 \mu A$	
Zero Gate Voltage Drain Current T _J = +25°C	IDSS	—	—	-1	μA	$V_{DS} = -60V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}	—	—	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 8)							
Gate Threshold Voltage	V _{GS(TH)}	-1.0	-	-3.0	V	$V_{DS} = V_{GS}$, $I_D = -250 \mu A$	
Static Drain-Source On-Resistance	Passa		34	48	mΩ	$V_{GS} = -10V, I_D = -5A$	
Static Drain-Source On-Resistance	R _{DS(ON)}	_	44	60	11122	$V_{GS} = -4.5V, I_D = -4A$	
Diode Forward Voltage	V _{SD}	-	-0.7	-1.2	V	$V_{GS} = 0V, I_{S} = -1A$	
DYNAMIC CHARACTERISTICS (Note 9)							
Input Capacitance	Ciss	—	1525	—	pF	N 00X/ X/ 0X/	
Output Capacitance	C _{oss}		90	_	pF	[−] V _{DS} = -30V, V _{GS} = 0V, −f = 1.0MHz	
Reverse Transfer Capacitance	Crss		70	-	pF		
Gate Resistance	Rg	_	16	—	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$	
Total Gate Charge (V _{GS} = -4.5V)	Qg	-	14.5	_	nC		
Total Gate Charge (V _{GS} = -10V)	Qg	_	30.6	—	nC	Vps = -30V. lp = -5A	
Gate-Source Charge	Q _{gs}	_	4.9	—	nC	$v_{DS} = -30v, I_D = -5A$	
Gate-Drain Charge	Q _{gd}		5.2	-	nC		
Turn-On Delay Time	t _{D(ON)}	—	5.3	—	ns		
Turn-On Rise Time	t _R	_	15.4	—	ns	$V_{GS} = -10V, V_{DS} = -30V,$	
Turn-Off Delay Time	t _{D(OFF)}	—	79.2	—	ns	$R_G = 3\Omega, I_D = -5A$	
Turn-Off Fall Time	t _F	—	45.3	—	ns]	
Body Diode Reverse Recovery Time	t _{RR}	—	15.2	—	ns	I _F = -5A, di/dt = -100A/µs	
Body Diode Reverse Recovery Charge	Q _{RR}	—	9.3	—	nC	I _F = -5A, di/dt = -100A/µs	

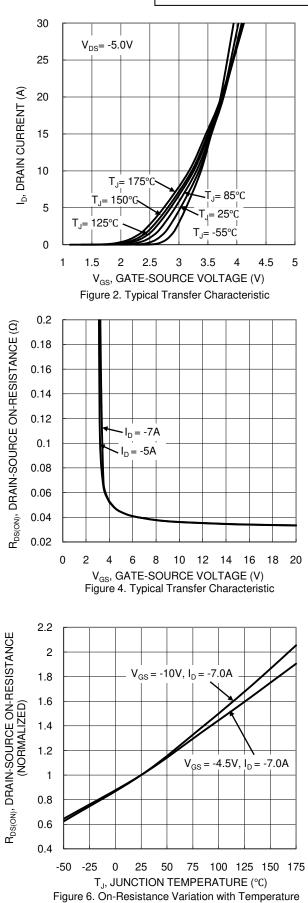
Notes:

Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.
Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.
I_{AS} and E_{AS} ratings are based on low frequency and duty cycles to keep T_J = +25°C.
Short duration pulse test used to minimize self-heating effect.
Guaranteed by design. Not subject to product testing.



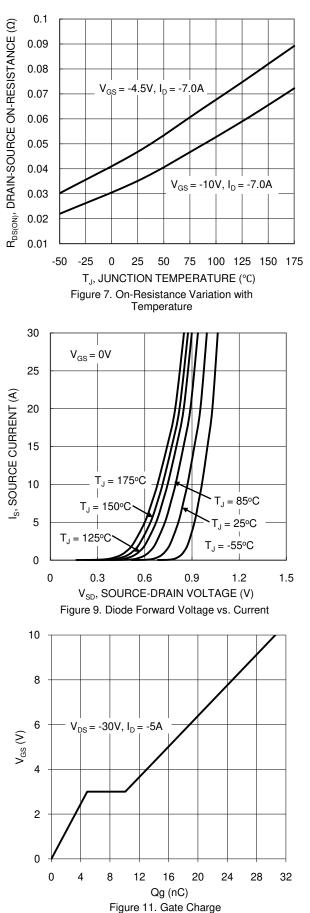
DMPH6050SSD

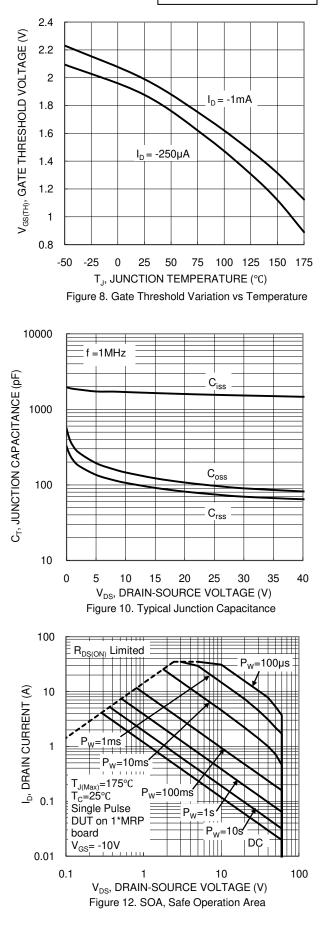






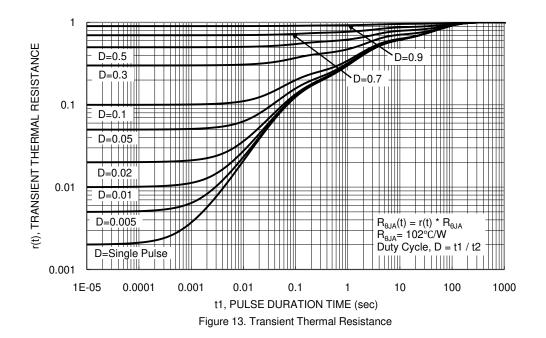
DMPH6050SSD





DMPH6050SSD Document number: DS38681 Rev.1 - 2

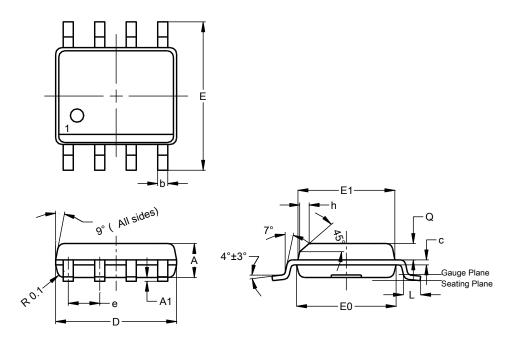






Package Outline Dimensions

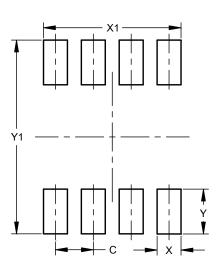
SO-8



SO-8					
Dim	Min Max Ty				
Α	1.40	1.50	1.45		
A1	0.10	0.20	0.15		
b	0.30	0.50	0.40		
C	0.15	0.25	0.20		
D	4.85	4.95	4.90		
Е	5.90	6.10	6.00		
E1	3.80	3.90	3.85		
E0	3.85	3.95	3.90		
e			1.27		
h	-		0.35		
L	0.62	0.82	0.72		
q	0.60	0.70	0.65		
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



SO-8

Dimensions	Value (in mm)			
С	1.27			
Х	0.802			
X1	4.612			
Y	1.505			
Y1	6.50			

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